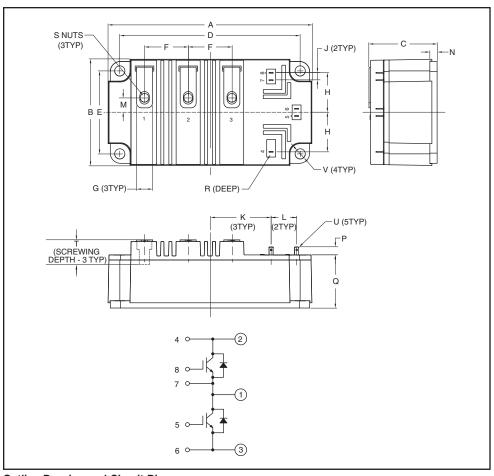


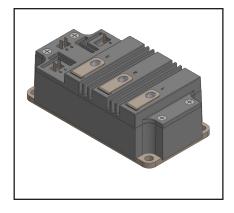
Dual IGBT HVIGBT Module 150 Amperes/4500 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters		
А	5.51	140.0		
В	2.87	73.0		
С	1.50	38.0		
D	4.88±0.01	124.0±0.25		
E	2.24±0.01	57.0±0.25		
F	1.18	30.0		
G	0.43	11.0		
Н	1.07	27.15		
J	0.20	5.0		
K	1.65	42.0		

Dimensions	Inches	Millimeters		
L	0.69±0.01	17.5±0.25		
М	0.38	9.75		
N	0.20	5.0		
Р	0.22	5.5		
Q	1.04	26.5		
R	0.16	4.0		
S	M5 Metric	M5		
Т	0.63 Min.	16.0 Min.		
U	0.11 x 0.02	2.8 x 0.5		
V	0.28 Dia.	7.0 Dia.		



Description:

Powerex HVIGBTs feature highly insulating housings that offer enhanced protection by means of greater creepage and strike clearance distance for many demanding applications like medium voltage drives and auxiliary traction applications.

Features:

- ☐ -40 to 150°C Extended Temperature Range
- ☐ 100% Dynamic Tested
- ☐ 100% Partial Discharge Tested
- ☐ Advanced Mitsubishi R-Series Chip Technology
- ☐ Aluminum Nitride (AIN) Ceramic Substrate for Low Thermal Impedance
- ☐ Complementary Line-up in Expanding Current Ranges to Mitsubishi HVIGBT Power Modules
- ☐ Copper Baseplate
- ☐ Creepage and Clearance Meet IEC 60077-1
- □ Rugged SWSOA and RRSOA

Applications:

- ☐ High Voltage Power Supplies
- ☐ Medium Voltage Drives
- ☐ Motor Drives
- □ Traction



QID4515004 **Dual IGBT HVIGBT Module** 150 Amperes/4500 Volts

Absolute Maximum Ratings, $T_i = 25$ °C unless otherwise specified

Ratings	Symbol	QID4515004	Units	
Junction Temperature	Tj	-40 to 150	°C	
Storage Temperature	T _{stg}	-40 to 125	°C	
Collector-Emitter Voltage ($V_{GE} = 0V$, $T_j = -40$ to $+125$ °C)	V _{CES}	4500	Volts	
Collector-Emitter Voltage ($V_{GE} = 0V, T_j = -50^{\circ}C$)	V _{CES}	4400	Volts	
Gate-Emitter Voltage (V _{CE} = 0V)	V _{GES}	±20	Volts	
Collector Current, DC (T _C = 82°C)	I _C	150	Amperes	
Peak Collector Current (Pulse)	I _{CM}	300*	Amperes	
Diode Forward Current**	I _F	150	Amperes	
Diode Forward Surge Current** (Pulse)	I _{FM}	300*	Amperes	
I^2 t for Diode (t = 10ms)	l ² t	10	kA ² sec	
Maximum Collector Dissipation (T _C = 25°C, IGBT Part, T _{j(max)} ≤ 150°C)	P _C	1580	Watts	
Mounting Torque, M5 Terminal Screws	_	35	in-lb	
Mounting Torque, M6 Mounting Screws	_	44	in-lb	
Module Weight (Typical)	_	800	Grams	
Isolation Voltage (Charged Part to Baseplate, AC 60Hz 1 min.)	V _{iso}	6.0	kVolts	
Partial Discharge	Q _{pd}	10	рС	
$(V1 = 3500 V_{RMS}, V2 = 2600 V_{RMS}, f = 60Hz (Acc. to IEC 1287))$	•			
Maximum Short-Circuit Pulse Width,	t _{psc}	10	μs	
$(V_{CC} \le 3200V, V_{GE} = 15V, T_i = 125^{\circ}C)$	•			

Electrical Characteristics, $T_j = 25$ °C unless otherwise specified

Symbol	Test Conditions	Min.	Typ.	Max.	Units
I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0V$	_	_	1.8	mA
I _{GES}	V _{GE} = V _{GES} , V _{CE} = 0V	_	_	0.5	μΑ
V _{GE(th)}	$I_C = 13.3$ mA, $V_{CE} = 10$ V	5.8	6.3	6.8	Volts
V _{CE(sat)}	$I_C = 150A$, $V_{GE} = 15V$, $T_j = 25$ °C	_	3.8	_	Volts
	I _C = 150A, V _{GE} = 15V, T _j = 125°C	_	4.6	5.5	Volts
Q_{G}	V _{CC} = 2800V, I _C = 150A, V _{GE} = 15V	_	1.5	_	μC
V _{EC}	I _E = 150A, V _{GE} = 0V, T _j = 25°C	_	2.8	_	Volts
	$I_E = 150A$, $V_{GE} = 0V$, $T_j = 125$ °C	_	3.2	3.8	Volts
	ICES IGES VGE(th) VCE(sat)	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

^{*} Pulse width and repetition rate should be such that device junction temperature (T_j) does not exceed $T_{j(max)}$ rating. **Represents characteristics od rhw anti-parallel, emitter-to-collector free-wheel diode (FWDi).



QID4515004 **Dual IGBT HVIGBT Module** 150 Amperes/4500 Volts

Electrical Characteristics, $T_i = 25$ °C unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance	C _{ies}		_	19	_	nF
Output Capacitance	C _{oes}	$V_{GE} = 0V, V_{CE} = 10V, f = 100kHz$	_	1.22	_	nF
Reverse Transfer Capacitance	C _{res}		_	0.55	_	nF
Turn-on Delay Time	t _{d(on)}	V _{CC} = 2800V, I _C = 133A,	_	1.00	_	μs
Rise Time	t _r	$V_{GE} = \pm 15V, R_{G(on)} = 24.3\Omega,$	_	0.30	_	μs
Turn-off Delay Time	t _{d(off)}	$R_{G(off)} = 90\Omega, L_{S} = 150nH$	_	3.6	_	μs
Fall Time	t _f	Inductive Load	_	0.36	_	μs
Turn-on Switching Energy	E _{on}	$T_j = 125$ °C, $I_C = 133$ A, $V_{GE} = \pm 15$ V,	_	0.55	_	J/P
Turn-off Switching Energy	E _{off}	$R_{G(on)} = 24.3\Omega, R_{G(off)} = 90\Omega,$	_	0.34	_	J/P
		V_{CC} = 2800V, L_S = 150nH , Inductive Loa	d			
Diode Reverse Recovery Time**	t _{rr}	V _{CC} = 2800V, I _E = 133A,	_	0.7	_	μs
Diode Reverse Recovery Charge**	Q _{rr}	$V_{GE} = \pm 15V, R_{G(on)} = 24.3\Omega,$	_	111*	_	μC
Diode Reverse Recovery Energy	E _{rec}	L _S = 150nH, Inductive Load	_	172	_	mJ/P
Stray Inductance (C1-E2)	L _{SCE}		_	60	_	nH
Lead Resistance Terminal-Chip	R _{CE}		_	0.8	_	mΩ

Thermal and Mechanical Characteristics, $T_j = 25$ °C unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Thermal Resistance, Junction to Case***	R _{th(j-c)} Q	Per IGBT	_	_	0.079	°K/W
Thermal Resistance, Junction to Case***	R _{th(j-c)} D	Per FWDi	_	_	0.149	°K/W
Contact Thermal Resistance, Case to Fin	R _{th(c-f)}	Per Module,	_	0.018	_	°K/W
		Thermal Grease Applied, $\lambda_{grease} = 1W/mK$				
Comparative Tracking Index	CTI		600	_	_	
Clearance Distance in Air (Terminal to Base)	d _{a(t-b)}		35.0	_	_	mm
Clearance Distance in Air	d _{a(t-t)}		19	_	_	mm
(Terminal to Terminal)						
Creepage Distance Along Surface	d _{s(t-t)}		54	_	_	mm
(Terminal to Terminal)						

^{*}Pulse width and repetition rate should be such that device junction temperature rise is negligible.

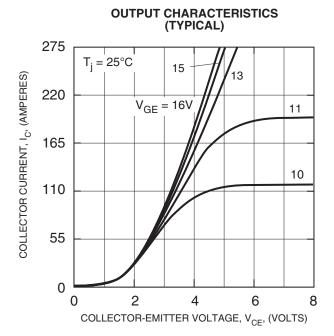
**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

***T_C measurement point is just under the chips.

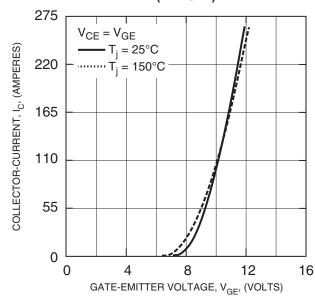


QID4515004 Dual IGBT HVIGBT Module 150 Amperes/4500 Volts

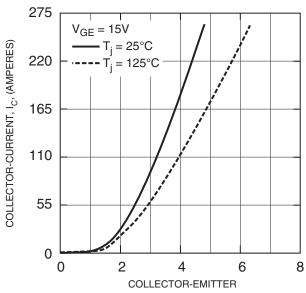
30 Amperes 14300 Voits



TRANSFER CHARACTERISTICS (TYPICAL)

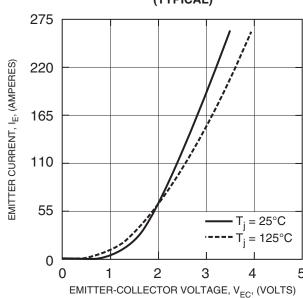


COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



SATURATION VOLTAGE, V_{CE(sat)}, (VOLTS)

FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)

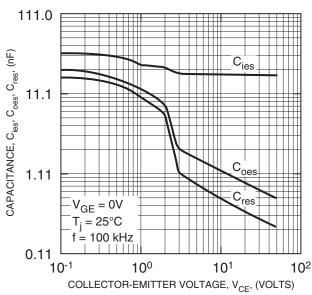




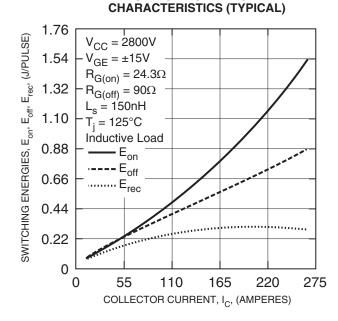
QID4515004 Dual IGBT HVIGBT Module

150 Amperes/4500 Volts

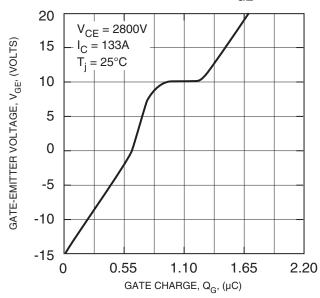




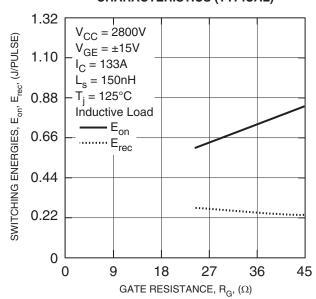
HALF-BRIDGE SWITCHING ENERGY



GATE CHARGE VS. VGE



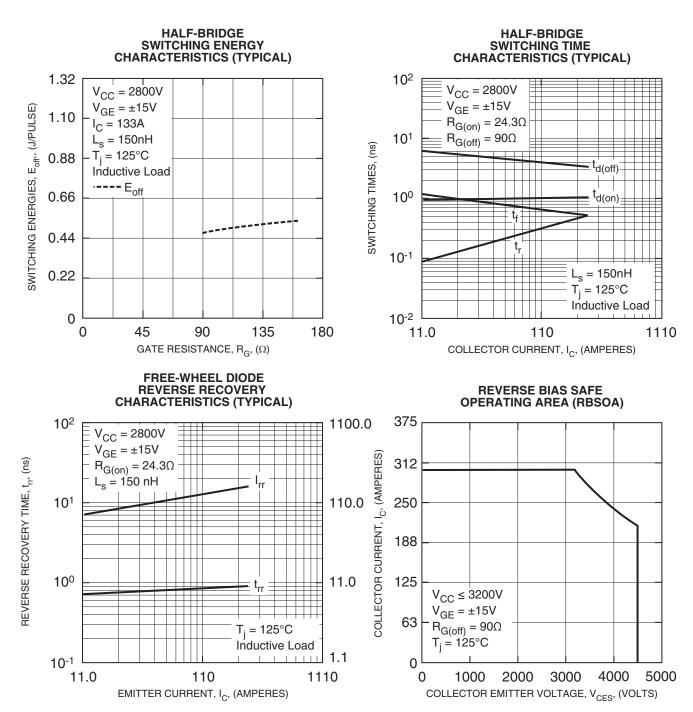
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)





QID4515004 Dual IGBT HVIGBT Module

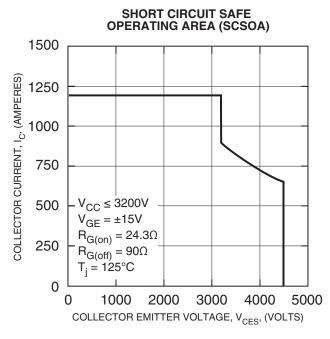
150 Amperes/4500 Volts

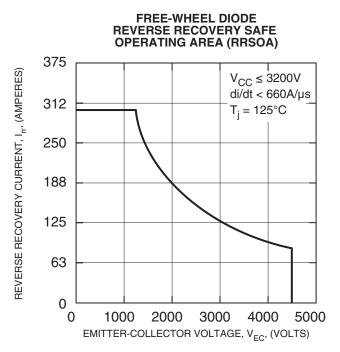




QID4515004 Dual IGBT HVIGBT Module 150 Amperes/4500 Volts

150 Amperes/4500 Volts





TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (IGBT & FWDi)

